Recent Results From The Timepix4 Telescope

TREDI Workshop 20-22nd February 2024

Federico De Benedetti, on behalf of Timepix4 telescope group









The University of Manchester







Timepix3 telescope:

• Achieved 1.6 µm pointing resolution at DUT, 236 ps track time resolution

K. Akiba et al 2019 JINST 14 P05026, K. Heijhoff et al 2020 JINST 15 P09035

Timepix4 telescope goals:

- Intrapixel characterization of sensor + ASIC assembly
- Proof of concept of a 4D tracker
- ~2 um pointing resolution at DUT
- Track time resolution combined with MCPs
- High track rate operations
- Two arms of 4 planes each
- DUT plane in the center
- Can translate and rotate up to grazing angle
- MCP-PMTs for time reference downstream

FEDERICO DE BENEDETTI - TREDI WORKSHOP

TIMEPIX4 TELESCOPE













TIMEPIX4 CHIP

			Timepix3 (2013)	Timepix4 (201
Technology			130nm – 8 metal	65nm – 10 met
Pixel Size			55 x 55 µm	55 x 55 µm
Pixel arrangement			3-side buttable 256 x 256	4-side buttabl 512 x 448
Sensitive area			1.98 cm ²	6.94 cm ²
Readout Modes	Data driven (Tracking)	Mode	TOT and TOA	
		Event Packet	48-bit	64-bit
		Max rate	0.43x10 ⁶ hits/mm ² /s	3.58x10 ⁶ hits/mr
		Max Pix rate	1.3 KHz/pixel	10.8 KHz/pixe
	Frame based (Imaging)	Mode	PC (10-bit) and iTOT (14-bit)	CRW: PC (8 or 16
		Frame	Zero-suppressed (with pixel addr)	Full Frame (without pi
		Max count rate	~0.82 x 10 ⁹ hits/mm ² /s	~5 x 10 ⁹ hits/mn
TOT energy resolution			< 2KeV	< 1Kev
TOA binning resolution			1.56ns	195ps
TOA dynamic range			409.6 µs (14-bits @ 40MHz)	1.6384 ms (16-bits @
Readout bandwidth			≤5.12Gb (8x SLVS@640 Mbps)	≤163.84 Gbps (16x @10.24 Gbps
Target minimum threshold			<500 e⁻	<500 e⁻









TIMEPIX4 TDC



- Status of 4 phase-shifted instances of VCO is latched at 40 MHz rising edge







TELESCOPE PLANES

- Eight telescope planes with n+-on-p planar silicon sensors:
 - 4 x 300 µm sensors for spatial resolution (angled 9°)
 - 4 x 100 µm sensors for time resolution (perpendicular)
- Several DUT assemblies
 - 50 μ m, 100 μ m and 200 μ m n+-on-p planar silicon
 - 300 µm p+-on-n planar silicon
 - 2 x 250 µm iLGAD sensors with 55 µm and 110 µm pitch (Timepix3 sized)
- All bump-bonded to Timepix4 V2 ASICs











TELESCOPE COOLING

- All assemblies have a 3D-printed titanium cooling block in contact with the PCB
- Cooled using a chiller with glycol at 20 °C
- Possible to go down to -20 °C in the future (especially in the DUT)
- Temperature and humidity monitoring
- Telescope box flushed with N2
- Plan to mill PCB to have direct thermal contact



















- Telescope installed at H8 beamline at SPS
- 180 GeV mixed hadron beam
- MCP-PMTs downstream of all other detectors to minimize the disturbance due to high material budget
- ~3 data-taking campaigns per year since 2022











TELESCOPE CONFIGURATION











MCPs TIMING REFERENCE SYSTEM

- Two microchannel plate photomultipliers (MCP-PMT) in coincidence
- CFD through Ortec9327, digitisation by PicoTDC
- Considering installing Timpix4 plane to VETO events with nuclear interactions
- Current time resolution: 17 ps (single MCP)
- Combined MCP resolution: 12 ps













SPATIAL RESOLUTION

- Pixel size $55 \mu m \times 55 \mu m$
- Four innermost planes rotated 9° around x and y to induce charge sharing between pixels
- Charge-weighted mean gives cluster position
- Optimal resolution achieved by using only clusters with width less or equal than 2
- ToT-to-charge calibration from test pulses in the laboratory
- η corrections applied to all planes
- Nominal per-plane resolution:
 - 3.6 μm (300 μm tilted sensors, 98% central interval)
 - 14.1 μm (100 μm orthogonal sensors, 98% central interval)



FEDERICO DE BENEDETTI - TREDI WORKSHOP



11











TRACKING POINT RESOLUTION

- Resolution driven by the four innermost planes (300 μ m, tilted)
- Pointing resolution at DUT: 2.5 μm
- Material budget per plane:
 - ASIC + sensor $\rightarrow 0.7-1.0\%$ X₀
 - PCB \rightarrow 1.8–2.4% X₀

Possible improvements:

- Milling the PCBs would reduce pointing resolution to $\sim 2.0 \ \mu m$
- Increase the number of 300 μm planes
 - Need 8 \times 300 μ m for ~1.6 μ m pointing resolution
- Move telescope arms further inwards if possible
- Operate Timepix4 at lower threshold

FEDERICO DE BENEDETTI - TREDI WORKSHOP

 σ [μ m] $\times \times$ $\times \times$ 1412 Preliminary 10 Plane resolution Х Plane resolution (masked) 8 Track pointing resolution 6 $\times \times$ $\times\!\!\times$ 2 -200200 400 -4000











TIME RESOLUTION

- Thin sensors have better weighting field and reduce timing errors
- Reduced signal size reduces analog front-end performance
- Perpendicular beam incidence maximizes signal charge in single pixel
- Pixel capacitance worsens the time resolution
- Modifying the DACs settings increasing the preamplifier bias current improves the resolution at the price of 15–20% increase of power usage















- Time measurement depends on signal size
- Reduced signal size makes timewalk corrections crucial



TIMEWALK

14













- Working on per-pixel timewalk corrections
- Corrections for variations of VCO
- Current cluster-time resolution: ~170 to 185 ps
- Track-time resolution with 4 planes: ~90 ps















- Timepix4 telescope is operational in stable conditions and commissioned. It is ready to test faster sensor technologies
- Up to 200 kHz track rate (limited by SPS H8 intensity)
- 2.5 μ m pointing resolution (will be improved by milling the PCBs and adding new 300 μ m tilted planes)
- 12 ps time resolution (very sensitive to material distribution upstream of the MCP-PMTs)
- Current timing track performance down to $\sigma_t \sim 90$ ps (4 × 100 µm orthogonal planar sensors)
- No correlations from clock distribution etc. pinpointed
- Studies of first DUTs (planar sensors + i-LGADs) are ongoing
- Plenty of data to be analyzed













Test beam crew

- CERN: Federico De Benedetti, Wiktor Byczynski, Victor Coco, Raphael Dumps, Morag Williams, Edgar LemosCid lacksquare
- *IGFAE*: Efrén Rodríguez Rodríguez
- TU Dortmund: Elena Dall'Occo, David Rolf
- University of Manchester/CERN: Tim Evans
- University of Oxford: David Bacher, Rui Gao, Fernanda Goncalves Abrantes, Tommaso Pajero ullet
- University of Birmingham: Dan Johnson, Marcus Jonathan Madurai
- University of Glasgow: Naomi Cooke, Aleksandrina Docheva ullet

And acknowledgements to everyone making this possible, including

FEDERICO DE BENEDETTI - TREDI WORKSHOP

• Nikhef: Kazu Akiba, Martin van Beuzekom, Tjip Bischoff, Robbert Geertsema, Kevin Heijhoff, Daan Oppenhuis, Ganrong Wang

• Richard Bates, Vincent van Beveren, Henk Boterenbrood, Paula Collins, Maarten van Dijk, Martin Fransen, Abraham Gallas Torreira, Vladimir Gromov, Bas van der Heijden, Malcolm John, Xavi Llopart, Loris Martinazolli, and Heinrich Schindler

























TIMEPIX4 FRONT END













η CORRECTIONS

- Charge sharing is non-linear \rightarrow bias in position reconstruction
- Charge asymmetry for multi-pixel clusters: $\eta = (QL QR)/QL$



FEDERICO DE BENEDETTI - TREDI WORKSHOP



100 µm

300 µm









